



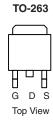
N-Channel 60-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Typ)	
60	0.0039 at V _{GS} = 10 V	110 ^a	200	

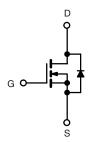
FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- High Threshold Voltage At High Temperature
- 100 % R_g Tested





Ordering Information: SUM110N06-3m9H-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATI	NGS $T_C = 25 ^{\circ}C$, unless other	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	60	V		
Gate-Source Voltage		V _{GS}	± 20	V	
0 11 0 1/7 175 00	T _C = 25 °C	1-	110 ^a	^	
Continuous Drain Current (T _J = 175 °C)	T _C = 125 °C	– I _D	110 ^a		
Pulsed Drain Current	I _{DM}	440	A A		
Single Pulse Avalanche Current	I _{AS}	70			
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	245	mJ	
Maximum Power Dissipation ^b	$T_C = 25 ^{\circ}C$	В	375 ^c	14/	
	T _A = 25 °C ^d	- P _D	3.75	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R_{thJC}	0.4	C/VV

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

SUM110N06-3m9H

Vishay Siliconix



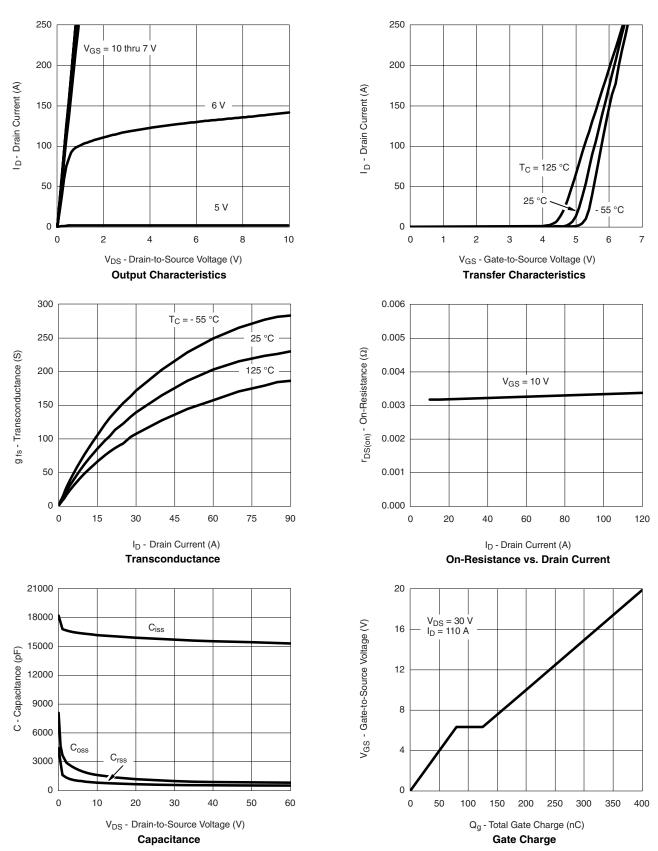
SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted					
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.4		4.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA	
Zero Gate Voltage Drain Current		V _{DS} = 60 V, V _{GS} = 0 V			1		
	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V _{GS} = 10 V, I _D = 30 A		0.00325	0.0039	Ω	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.0063		
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.0082		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S	
Dynamic ^b	•			•			
Input Capacitance	C _{iss}			15 800		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1050			
Reverse Transfer Capacitance	C _{rss}			600			
Gate Resistance	R_g	f = 1 MHz	0.6	1.2	1.8	Ω	
Total Gate Charge ^c	Qg			200	300		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$		80		nC	
Gate-Drain Charge ^c	Q _{gd}			45			
Turn-On Delay Time ^c	t _{d(on)}			45	70		
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 0.27 \Omega$		160	240	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 110 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		75	115		
Fall Time ^c	t _f			14	25		
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b		1			
Continuous Current	I _S				110	А .	
Pulsed Current	I _{SM}				240		
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.1	1.5	V	
Reverse Recovery Time	t _{rr}			65	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 85 A, di/dt = 100 A/μs		4.4	6.6	Α	
Reverse Recovery Charge	Q _{rr}			143	330	nC	

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



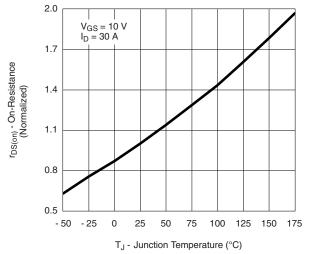
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



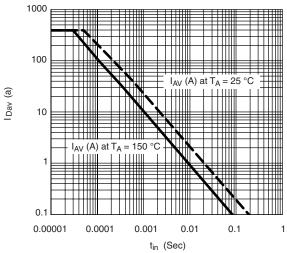
Vishay Siliconix

VISHAY

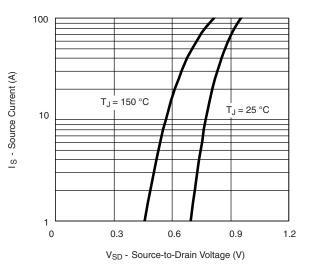
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



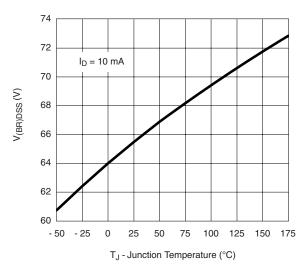
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



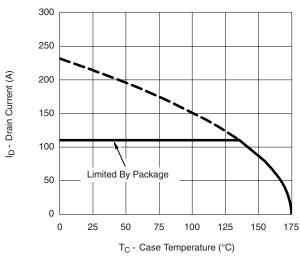
Source-Drain Diode Forward Voltage

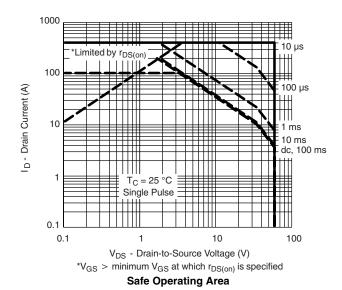


Drain Source Breakdown vs. Junction Temperature

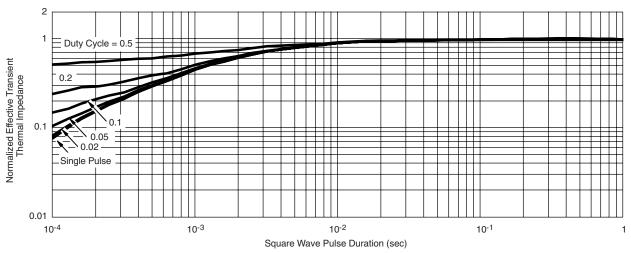


THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73236.



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08